







Layer	Name	Material	Thickness	Constant	Board Layer Sta	ack
	Top Overlay					
	Top Solder	Solder Resist	0.40mil	3.5		
1	Top Layer	Copper	1.40mil			
	Dielectric 2	PP-006	2.80mil	4.1		
2	Layer 1	Copper	1.38mil			
	Dielectric 1	FR-4	12.60mil	4.8		
3	Layer 2	Copper	1.38mil			
	Dielectric 3	PP-006	2.80mil	4.1		
4	Bottom Layer	Copper	1.40mil			
	Bottom Solder	Solder Resist	0.40mil	3.5		
	Bottom Overlau					////



